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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 185000  |
| Number of Logic Elements/Cells | 490000  |
| Total RAM Bits                 | 41984000  |
| Number of I/O                  | 432   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.82V ~ 0.88V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 85°C (TJ)   |
| Package / Case                 | 1517-FBGA (40x40)   |
| Supplier Device Package        | 1517-FBGA (40x40)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxeb5r1f40c2l">https://www.e-xfl.com/product-detail/intel/5sgxeb5r1f40c2l</a> |

**Table 6. Recommended Operating Conditions for Stratix V Devices (Part 2 of 2)**

| Symbol            | Description            | Condition    | Min <sup>(4)</sup> | Typ | Max <sup>(4)</sup> | Unit |
|-------------------|------------------------|--------------|--------------------|-----|--------------------|------|
| t <sub>RAMP</sub> | Power supply ramp time | Standard POR | 200 $\mu$ s        | —   | 100 ms             | —    |
|                   |                        | Fast POR     | 200 $\mu$ s        | —   | 4 ms               | —    |

**Notes to Table 6:**

- (1) V<sub>CCPD</sub> must be 2.5 V when V<sub>CCIO</sub> is 2.5, 1.8, 1.5, 1.35, 1.25 or 1.2 V. V<sub>CCPD</sub> must be 3.0 V when V<sub>CCIO</sub> is 3.0 V.
- (2) If you do not use the design security feature in Stratix V devices, connect V<sub>CCBAT</sub> to a 1.2- to 3.0-V power supply. Stratix V power-on-reset (POR) circuitry monitors V<sub>CCBAT</sub>. Stratix V devices will not exit POR if V<sub>CCBAT</sub> stays at logic low.
- (3) C2L and I2L can also be run at 0.90 V for legacy boards that were designed for the C2 and I2 speed grades.
- (4) The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 7 lists the transceiver power supply recommended operating conditions for Stratix V GX, GS, and GT devices.

**Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 1 of 2)**

| Symbol                            | Description   | Devices    | Minimum <sup>(4)</sup> | Typical | Maximum <sup>(4)</sup> | Unit |
|-----------------------------------|---|------------|------------------------|---------|------------------------|------|
| V <sub>CCA_GXBL</sub><br>(1), (3) | Transceiver channel PLL power supply (left side)  | GX, GS, GT | 2.85                   | 3.0     | 3.15                   | V    |
|                                   |   |            | 2.375                  | 2.5     | 2.625                  |      |
| V <sub>CCA_GXBR</sub><br>(1), (3) | Transceiver channel PLL power supply (right side)   | GX, GS     | 2.85                   | 3.0     | 3.15                   | V    |
|                                   |   |            | 2.375                  | 2.5     | 2.625                  |      |
| V <sub>CCA_GTBR</sub>             | Transceiver channel PLL power supply (right side)   | GT         | 2.85                   | 3.0     | 3.15                   | V    |
| V <sub>CCHIP_L</sub>              | Transceiver hard IP power supply (left side; C1, C2, I2, and I3YY speed grades)               | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver hard IP power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHIP_R</sub>              | Transceiver hard IP power supply (right side; C1, C2, I2, and I3YY speed grades)              | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver hard IP power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHSSI_L</sub>             | Transceiver PCS power supply (left side; C1, C2, I2, and I3YY speed grades)                   | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver PCS power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)      | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHSSI_R</sub>             | Transceiver PCS power supply (right side; C1, C2, I2, and I3YY speed grades)                  | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver PCS power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)     | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCR_GXBL</sub><br>(2)      | Receiver analog power supply (left side)  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
|                                   |   |            | 0.87                   | 0.90    | 0.93                   |      |
|                                   |   |            | 0.97                   | 1.0     | 1.03                   |      |
|                                   |   |            | 1.03                   | 1.05    | 1.07                   |      |

## I/O Pin Leakage Current

Table 9 lists the Stratix V I/O pin leakage current specifications.

Table 9. I/O Pin Leakage Current for Stratix V Devices<sup>(1)</sup>

| Symbol   | Description        | Conditions                        | Min | Typ | Max | Unit          |
|----------|--------------------|-----------------------------------|-----|-----|-----|---------------|
| $I_I$    | Input pin          | $V = 0 \text{ V to } V_{CCIOMAX}$ | -30 | —   | 30  | $\mu\text{A}$ |
| $I_{OZ}$ | Tri-stated I/O pin | $V = 0 \text{ V to } V_{CCIOMAX}$ | -30 | —   | 30  | $\mu\text{A}$ |

Note to Table 9

(1) If  $V_O = V_{CCIO}$  to  $V_{CCIOMAX}$  100  $\mu\text{A}$  of leakage current per I/O is expected.

## Bus Hold Specifications

Table 10 lists the Stratix V device family bus hold specifications.

Table 10. Bus Hold Parameters for Stratix V Devices

| Parameter               | Symbol            | Conditions                                    | V <sub>CCIO</sub> |      |       |        |              |      |       |      |       |      | Unit |
|-------------------------|-------------------|---|-------------------|------|-------|--------|--------------|------|-------|------|-------|------|------|
|                         |                   |   | 1.2 V             |      | 1.5 V |        | 1.8 V        |      | 2.5 V |      | 3.0 V |      |      |
|                         |                   |   | Min               | Max  | Min   | Max    | Min          | Max  | Min   | Max  | Min   | Max  |      |
| Low sustaining current  | I <sub>SUSL</sub> | V <sub>IN</sub> > V <sub>L</sub><br>(maximum) | 22.5              | —    | 25.0  | —      | 30.0         | —    | 50.0  | —    | 70.0  | —    | μA   |
| High sustaining current | I <sub>SUSH</sub> | V <sub>IN</sub> < V <sub>H</sub><br>(minimum) | −22.5             | —    | −25.0 | —      | −30.0        | —    | −50.0 | —    | −70.0 | —    | μA   |
| Low overdrive current   | I <sub>ODL</sub>  | 0V < V <sub>N</sub> < V <sub>CCIO</sub>       | —                 | 120  | —     | 160    | —            | 200  | —     | 300  | —     | 500  | μA   |
| High overdrive current  | I <sub>ODH</sub>  | 0V < V <sub>N</sub> < V <sub>CCIO</sub>       | —                 | −120 | —     | −160   | —            | −200 | —     | −300 | —     | −500 | μA   |
| Bus-hold trip point     | V <sub>TRIP</sub> | —   | 0.45              | 0.95 | 0.50  | 1.1 TD | 41.6(4 3330) | 160  | 9.40  |      |       |      |      |

## On-Chip Termination (OCT) Specifications

If you enable OCT calibration, calibration is automatically performed at power-up for I/Os connected to the calibration block. Table 11 lists the Stratix V OCT termination calibration accuracy specifications.

**Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices <sup>(1)</sup> (Part 2 of 2)**

| Symbol   | Description  | Conditions                                    | Calibration Accuracy |            |                |            | Unit |
|--|--|---|----------------------|------------|----------------|------------|------|
|  |  |   | C1                   | C2,I2      | C3,I3,<br>I3YY | C4,I4      |      |
| 50-Ω R <sub>S</sub>                              | Internal series termination with calibration (50-Ω setting)                                      | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15            | ±15        | %    |
| 34-Ω and 40-Ω R <sub>S</sub>                     | Internal series termination with calibration (34-Ω and 40-Ω setting)                             | V <sub>CCIO</sub> = 1.5, 1.35, 1.25, 1.2 V    | ±15                  | ±15        | ±15            | ±15        | %    |
| 48-Ω, 60-Ω, 80-Ω, and 240-Ω R <sub>S</sub>       | Internal series termination with calibration (48-Ω, 60-Ω, 80-Ω, and 240-Ω setting)               | V <sub>CCIO</sub> = 1.2 V                     | ±15                  | ±15        | ±15            | ±15        | %    |
| 50-Ω R <sub>T</sub>                              | Internal parallel termination with calibration (50-Ω setting)                                    | V <sub>CCIO</sub> = 2.5, 1.8, 1.5, 1.2 V      | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω R <sub>T</sub> | Internal parallel termination with calibration (20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω setting)       | V <sub>CCIO</sub> = 1.5, 1.35, 1.25 V         | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 60-Ω and 120-Ω R <sub>T</sub>                    | Internal parallel termination with calibration (60-Ω and 120-Ω setting)                          | V <sub>CCIO</sub> = 1.2                       | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 25-Ω R <sub>S_left_shift</sub>                   | Internal left shift series termination with calibration (25-Ω R <sub>S_left_shift</sub> setting) | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15            | ±15        | %    |

**Note to Table 11:**

(1) OCT calibration accuracy is valid at the time of calibration only.

Table 12 lists the Stratix V OCT without calibration resistance tolerance to PVT changes.

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 1 of 2)**

| Symbol                      | Description  | Conditions                        | Resistance Tolerance |       |                 |        | Unit |
|-----------------------------|--|-----------------------------------|----------------------|-------|-----------------|--------|------|
|                             |  |                                   | C1                   | C2,I2 | C3, I3,<br>I3YY | C4, I4 |      |
| 25-Ω R, 50-Ω R <sub>S</sub> | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 3.0 and 2.5 V | ±30                  | ±30   | ±40             | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30   | ±40             | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35   | ±50             | ±50    | %    |

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 2 of 2)**

| Symbol               | Description  | Conditions                        | Resistance Tolerance |        |              |        | Unit |
|----------------------|--|-----------------------------------|----------------------|--------|--------------|--------|------|
|                      |  |                                   | C1                   | C2, I2 | C3, I3, I3YY | C4, I4 |      |
| 50-Ω R <sub>S</sub>  | Internal series termination without calibration (50-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30    | ±40          | ±40    | %    |
| 50-Ω R <sub>S</sub>  | Internal series termination without calibration (50-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35    | ±50          | ±50    | %    |
| 100-Ω R <sub>D</sub> | Internal differential termination (100-Ω setting)              | V <sub>CCPD</sub> = 2.5 V         | ±25                  | ±25    | ±25          | ±25    | %    |

Calibration accuracy for the calibrated series and parallel OCTs are applicable at the moment of calibration. When voltage and temperature conditions change after calibration, the tolerance may change.

OCT calibration is automatically performed at power-up for OCT-enabled I/Os. Table 13 lists the OCT variation with temperature and voltage after power-up calibration. Use Table 13 to determine the OCT variation after power-up calibration and Equation 1 to determine the OCT variation without recalibration.

**Equation 1. OCT Variation Without Recalibration for Stratix V Devices <sup>(1), (2), (3), (4), (5), (6)</sup>**

$$R_{OCT} = R_{SCAL} \left( 1 + \left\langle \frac{dR}{dT} \times \Delta T \right\rangle \pm \left\langle \frac{dR}{dV} \times \Delta V \right\rangle \right)$$

**Notes to Equation 1:**

- (1) The R<sub>OCT</sub> value shows the range of OCT resistance with the variation of temperature and V<sub>CCIO</sub>.
- (2) R<sub>SCAL</sub> is the OCT resistance value at power-up.
- (3) ΔT is the variation of temperature with respect to the temperature at power-up.
- (4) ΔV is the variation of voltage with respect to the V<sub>CCIO</sub> at power-up.
- (5) dR/dT is the percentage change of R<sub>SCAL</sub> with temperature.
- (6) dR/dV is the percentage change of R<sub>SCAL</sub> with voltage.

Table 13 lists the on-chip termination variation after power-up calibration.

**Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 1 of 2) <sup>(1)</sup>**

| Symbol | Description                                      | V <sub>CCIO</sub> (V) | Typical | Unit |
|--------|--|-----------------------|---------|------|
| dR/dV  | OCT variation with voltage without recalibration | 3.0                   | 0.0297  | %/mV |
|        |  | 2.5                   | 0.0344  |      |
|        |  | 1.8                   | 0.0499  |      |
|        |  | 1.5                   | 0.0744  |      |
|        |  | 1.2                   | 0.1241  |      |



## Internal Weak Pull-Up Resistor

Table 16 lists the weak pull-up resistor values for Stratix V devices.

**Table 16. Internal Weak Pull-Up Resistor for Stratix V Devices <sup>(1), (2)</sup>**

| Symbol          | Description   | V <sub>CCIO</sub> Conditions (V) <sup>(3)</sup> | Value <sup>(4)</sup> | Unit |
|-----------------|---|---|----------------------|------|
| R <sub>PU</sub> | Value of the I/O pin pull-up resistor before and during configuration, as well as user mode if you enable the programmable pull-up resistor option. | 3.0 ±5%   | 25                   | kΩ   |
|                 |   | 2.5 ±5%   | 25                   | kΩ   |
|                 |   | 1.8 ±5%   | 25                   | kΩ   |
|                 |   | 1.5 ±5%   | 25                   | kΩ   |
|                 |   | 1.35 ±5%  | 25                   | kΩ   |
|                 |   | 1.25 ±5%  | 25                   | kΩ   |
|                 |   | 1.2 ±5%   | 25                   | kΩ   |

### Notes to Table 16:

- (1) All I/O pins have an option to enable the weak pull-up resistor except the configuration, test, and JTAG pins.
- (2) The internal weak pull-down feature is only available for the JTAG TCK pin. The typical value for this internal weak pull-down resistor is approximately 25 kΩ.
- (3) The pin pull-up resistance values may be lower if an external source drives the pin higher than V<sub>CCIO</sub>.
- (4) These specifications are valid with a ±10% tolerance to cover changes over PVT.

## I/O Standard Specifications

Table 17 through Table 22 list the input voltage (V<sub>IH</sub> and V<sub>IL</sub>), output voltage (V<sub>OH</sub> and V<sub>OL</sub>), and current drive characteristics (I<sub>OH</sub> and I<sub>OL</sub>) for various I/O standards supported by Stratix V devices. These tables also show the Stratix V device family I/O standard specifications. The V<sub>OL</sub> and V<sub>OH</sub> values are valid at the corresponding I<sub>OH</sub> and I<sub>OL</sub>, respectively.

For an explanation of the terms used in Table 17 through Table 22, refer to “Glossary” on page 65. For tolerance calculations across all SSTL and HSTL I/O standards, refer to Altera knowledge base solution rd07262012\_486.

**Table 17. Single-Ended I/O Standards for Stratix V Devices**

| I/O Standard | V <sub>CCIO</sub> (V) |     |       | V <sub>IL</sub> (V) |                             | V <sub>IH</sub> (V)         |                         | V <sub>OL</sub> (V)         | V <sub>OH</sub> (V)         | I <sub>OL</sub> (mA) | I <sub>OH</sub> (mA) |
|--------------|-----------------------|-----|-------|---------------------|-----------------------------|-----------------------------|-------------------------|-----------------------------|-----------------------------|----------------------|----------------------|
|              | Min                   | Typ | Max   | Min                 | Max                         | Min                         | Max                     | Max                         | Min                         |                      |                      |
| LVTTTL       | 2.85                  | 3   | 3.15  | −0.3                | 0.8                         | 1.7                         | 3.6                     | 0.4                         | 2.4                         | 2                    | −2                   |
| LVC MOS      | 2.85                  | 3   | 3.15  | −0.3                | 0.8                         | 1.7                         | 3.6                     | 0.2                         | V <sub>CCIO</sub> − 0.2     | 0.1                  | −0.1                 |
| 2.5 V        | 2.375                 | 2.5 | 2.625 | −0.3                | 0.7                         | 1.7                         | 3.6                     | 0.4                         | 2                           | 1                    | −1                   |
| 1.8 V        | 1.71                  | 1.8 | 1.89  | −0.3                | 0.35 *<br>V <sub>CCIO</sub> | 0.65 *<br>V <sub>CCIO</sub> | V <sub>CCIO</sub> + 0.3 | 0.45                        | V <sub>CCIO</sub> − 0.45    | 2                    | −2                   |
| 1.5 V        | 1.425                 | 1.5 | 1.575 | −0.3                | 0.35 *<br>V <sub>CCIO</sub> | 0.65 *<br>V <sub>CCIO</sub> | V <sub>CCIO</sub> + 0.3 | 0.25 *<br>V <sub>CCIO</sub> | 0.75 *<br>V <sub>CCIO</sub> | 2                    | −2                   |
| 1.2 V        | 1.14                  | 1.2 | 1.26  | −0.3                | 0.35 *<br>V <sub>CCIO</sub> | 0.65 *<br>V <sub>CCIO</sub> | V <sub>CCIO</sub> + 0.3 | 0.25 *<br>V <sub>CCIO</sub> | 0.75 *<br>V <sub>CCIO</sub> | 2                    | −2                   |

**Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 2 of 2)**

| I/O Standard        | V <sub>CCIO</sub> (V) |     |      | V <sub>DIF(DC)</sub> (V) |                         | V <sub>X(AC)</sub> (V)        |                        |                               | V <sub>CM(DC)</sub> (V) |                        |                        | V <sub>DIF(AC)</sub> (V) |                          |
|---------------------|-----------------------|-----|------|--------------------------|-------------------------|-------------------------------|------------------------|-------------------------------|-------------------------|------------------------|------------------------|--------------------------|--------------------------|
|                     | Min                   | Typ | Max  | Min                      | Max                     | Min                           | Typ                    | Max                           | Min                     | Typ                    | Max                    | Min                      | Max                      |
| HSTL-12 Class I, II | 1.14                  | 1.2 | 1.26 | 0.16                     | V <sub>CCIO</sub> + 0.3 | —                             | 0.5* V <sub>CCIO</sub> | —                             | 0.4* V <sub>CCIO</sub>  | 0.5* V <sub>CCIO</sub> | 0.6* V <sub>CCIO</sub> | 0.3                      | V <sub>CCIO</sub> + 0.48 |
| HSUL-12             | 1.14                  | 1.2 | 1.3  | 0.26                     | 0.26                    | 0.5* V <sub>CCIO</sub> - 0.12 | 0.5* V <sub>CCIO</sub> | 0.5* V <sub>CCIO</sub> + 0.12 | 0.4* V <sub>CCIO</sub>  | 0.5* V <sub>CCIO</sub> | 0.6* V <sub>CCIO</sub> | 0.44                     | 0.44                     |

**Table 22. Differential I/O Standard Specifications for Stratix V Devices <sup>(7)</sup>**

| I/O Standard  | V <sub>CCIO</sub> (V) <sup>(10)</sup> |     |       | V <sub>ID</sub> (mV) <sup>(8)</sup> |                          |     | V <sub>ICM(DC)</sub> (V) |                             |       | V <sub>OD</sub> (V) <sup>(6)</sup> |     |     | V <sub>OCM</sub> (V) <sup>(6)</sup> |      |       |
|---|---------------------------------------|-----|-------|-------------------------------------|--------------------------|-----|--------------------------|-----------------------------|-------|------------------------------------|-----|-----|-------------------------------------|------|-------|
|   | Min                                   | Typ | Max   | Min                                 | Condition                | Max | Min                      | Condition                   | Max   | Min                                | Typ | Max | Min                                 | Typ  | Max   |
| PCML Transmitter, receiver, and input reference clock pins of the high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Table 23 on page 18. |                                       |     |       |                                     |                          |     |                          |                             |       |                                    |     |     |                                     |      |       |
| 2.5 V LVDS <sup>(1)</sup>   | 2.375                                 | 2.5 | 2.625 | 100                                 | V <sub>CM</sub> = 1.25 V | —   | 0.05                     | D <sub>MAX</sub> ≤ 700 Mbps | 1.8   | 0.247                              | —   | 0.6 | 1.125                               | 1.25 | 1.375 |
|   |                                       |     |       |                                     |                          | —   | 1.05                     | D <sub>MAX</sub> > 700 Mbps | 1.55  | 0.247                              | —   | 0.6 | 1.125                               | 1.25 | 1.375 |
| BLVDS <sup>(5)</sup>  | 2.375                                 | 2.5 | 2.625 | 100                                 | —                        | —   | —                        | —                           | —     | —                                  | —   | —   | —                                   | —    | —     |
| RSDS (HIO) <sup>(2)</sup>   | 2.375                                 | 2.5 | 2.625 | 100                                 | V <sub>CM</sub> = 1.25 V | —   | 0.3                      | —                           | 1.4   | 0.1                                | 0.2 | 0.6 | 0.5                                 | 1.2  | 1.4   |
| Mini-LVDS (HIO) <sup>(3)</sup>  | 2.375                                 | 2.5 | 2.625 | 200                                 | —                        | 600 | 0.4                      | —                           | 1.325 | 0.25                               | —   | 0.6 | 1                                   | 1.2  | 1.4   |
| LVPECL <sup>(4)</sup> , <sup>(9)</sup>  | —                                     | —   | —     | 300                                 | —                        | —   | 0.6                      | D <sub>MAX</sub> ≤ 700 Mbps | 1.8   | —                                  | —   | —   | —                                   | —    | —     |
|   |                                       |     |       |                                     |                          |     | 1                        | D <sub>MAX</sub> > 700 Mbps | 1.6   | —                                  | —   | —   | —                                   | —    | —     |

**Notes to Table 22:**

- (1) For optimized LVDS receiver performance, the receiver voltage input range must be between 1.0 V to 1.6 V for data rates above 700 Mbps, and 0 V to 1.85 V for data rates below 700 Mbps.
- (2) For optimized RSDS receiver performance, the receiver voltage input range must be between 0.25 V to 1.45 V.
- (3) For optimized Mini-LVDS receiver performance, the receiver voltage input range must be between 0.3 V to 1.425 V.
- (4) For optimized LVPECL receiver performance, the receiver voltage input range must be between 0.85 V to 1.75 V for data rate above 700 Mbps and 0.45 V to 1.95 V for data rate below 700 Mbps.
- (5) There are no fixed V<sub>ICM</sub>, V<sub>OD</sub>, and V<sub>OCM</sub>

## Power Consumption

Altera offers two ways to estimate power consumption for a design—the Excel-based Early Power Estimator and the Quartus® II PowerPlay Power Analyzer feature.



## Switching Characteristics

This section provides performance characteristics of the Stratix V core and periphery blocks.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The title of these tables show the designation as “Preliminary.”
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

### Transceiver Performance Specifications

This section describes transceiver performance specifications.

Table 23 lists the Stratix V GX and GS transceiver specifications.

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 1 of 7)**

| Symbol/<br>Description   | Conditions  | Transceiver Speed<br>Grade 1  |     |     | Transceiver Speed<br>Grade 2 |     |     | Transceiver Speed<br>Grade 3 |     |     | Unit |
|--|---|---|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
|  |   | Min   | Typ | Max | Min                          | Typ | Max | Min                          | Typ | Max |      |
| Reference Clock  |   |   |     |     |                              |     |     |                              |     |     |      |
| Supported I/O<br>Standards                                     | Dedicated<br>reference<br>clock pin                               | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL |     |     |                              |     |     |                              |     |     |      |
|  | RX reference<br>clock pin   | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS                                |     |     |                              |     |     |                              |     |     |      |
| Input Reference<br>Clock Frequency<br>(CMU PLL) <sup>(8)</sup> | —   | 40  | —   | 710 | 40                           | —   | 710 | 40                           | —   | 710 | MHz  |
| Input Reference<br>Clock Frequency<br>(ATX PLL) <sup>(8)</sup> | —   | 100   | —   | 710 | 100                          | —   | 710 | 100                          | —   | 710 | MHz  |
| Rise time  | Measure at<br>±60 mV of<br>differential<br>signal <sup>(26)</sup> | —   | —   | 400 | —                            | —   | 400 | —                            | —   | 400 | ps   |
| Fall time  | Measure at<br>±60 mV of<br>differential<br>signal <sup>(26)</sup> | —   | —   | 400 | —                            | —   | 400 | —                            | —   | 400 |      |
| Duty cycle   | —   | 45  | —   | 55  | 45                           | —   | 55  | 45                           | —   | 55  | %    |
| Spread-spectrum<br>modulating clock<br>frequency               | PCI Express®<br>(PCIe®)   | 30  | —   | 33  | 30                           | —   | 33  | 30                           | —   | 33  | kHz  |

|  |   |   |   |    |   |   |    |   |   |    |    |
|--|---|---|---|----|---|---|----|---|---|----|----|
| $t_{\text{pll\_lock}}$ <sup>(16)</sup> | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |
|--|---|---|---|----|---|---|----|---|---|----|----|

**Notes to Table 23:**

- (1) Speed grades shown in Table 23 refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the *Stratix V Device Overview*.
- (2) The reference clock common mode voltage is equal to the  $V_{\text{CCR\_GXB}}$  power supply level.
- (3) This supply must be connected to 1.0 V if the transceiver is configured at a data rate > 6.5 Gbps, and to 1.05 V if configured at a data rate > 10.3 Gbps when DFE is used. For data rates up to 6.5 Gbps, you can connect this supply to 0.85 V.
- (4) This supply follows  $V_{\text{CCR\_GXB}}$ .
- (5) The device cannot tolerate prolonged operation at this absolute maximum.
- (6) The differential eye opening specification at the receiver input pins assumes that **Receiver Equalization** is disabled. If you enable **Receiver Equalization**, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (7) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (8) The input reference clock frequency options depend on the data rate and the device speed grade.
- (9) The line data rate may be limited by PCS-FPGA interface speed grade.
- (10) Refer to Figure 1 for the GX channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (11)  $t_{\text{LTR}}$  is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (12)  $t_{\text{LTD}}$  is time required for the receiver CDR to start recovering valid data after the rx\_is\_lockedtodata signal goes high.
- (13)  $t_{\text{LTD\_manual}}$  is the time required for the receiver CDR to start recovering valid data after the rx\_is\_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (14)  $t_{\text{LTR\_LTD\_manual}}$  is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx\_is\_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (15)  $t_{\text{pll\_powerdown}}$  is the PLL powerdown minimum pulse width.
- (16)  $t_{\text{pll\_lock}}$  is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (17) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula:  
REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz  $\times$  100/f.
- (18) The maximum peak to peak differential input voltage  $V_{\text{ID}}$  after device configuration is equal to  $4 \times (\text{absolute } V_{\text{MAX}} \text{ for receiver pin} - V_{\text{ICM}})$ .
- (19) For ES devices,  $R_{\text{REF}}$  is  $2000 \Omega \pm 1\%$ .
- (20) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz +  $20 \times \log(f/622)$ .
- (21) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with  $100 \Omega$ . The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (22) Refer to Figure 2.
- (23) For oversampling designs to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (24) I3YY devices can achieve data rates up to 10.3125 Gbps.
- (25) When you use fPLL as a TXPLL of the transceiver.
- (26) REFCLK performance requires to meet transmitter

Table 24 shows the maximum transmitter data rate for the clock network.

**Table 24. Clock Network Maximum Data Rate Transmitter Specifications <sup>(1)</sup>**

| Clock Network                  | ATX PLL                |                    |                                       | CMU PLL <sup>(2)</sup> |                    |                                       | fPLL                   |                    |                                       |
|--------------------------------|------------------------|--------------------|---------------------------------------|------------------------|--------------------|---------------------------------------|------------------------|--------------------|---------------------------------------|
|                                | Non-bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span                          | Non-bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span                          | Non-bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span                          |
| x1 <sup>(3)</sup>              | 14.1                   | —                  | 6                                     | 12.5                   | —                  | 6                                     | 3.125                  | —                  | 3                                     |
| x6 <sup>(3)</sup>              | —                      | 14.1               | 6                                     | —                      | 12.5               | 6                                     | —                      | 3.125              | 6                                     |
| x6 PLL Feedback <sup>(4)</sup> | —                      | 14.1               | Side-wide                             | —                      | 12.5               | Side-wide                             | —                      | —                  | —                                     |
| xN (PCIe)                      | —                      | 8.0                | 8                                     | —                      | 5.0                | 8                                     | —                      | —                  | —                                     |
| xN (Native PHY IP)             | 8.0                    | 8.0                | Up to 13 channels above and below PLL | 7.99                   | 7.99               | Up to 13 channels above and below PLL | 3.125                  | 3.125              | Up to 13 channels above and below PLL |
|                                | —                      | 8.01 to 9.8304     | Up to 7 channels above and below PLL  |                        |                    |                                       |                        |                    |                                       |

**Notes to Table 24:**

- (1) Valid data rates below the maximum specified in this table depend on the reference clock frequency and the PLL counter settings. Check the MegaWizard message during the PHY IP instantiation.
- (2) ATX PLL is recommended at 8 Gbps and above data rates for improved jitter performance.
- (3) Channel span is within a transceiver bank.
- (4) Side-wide channel bonding is allowed up to the maximum supported by the PHY IP.

Table 27 shows the  $V_{OD}$  settings for the GX channel.

**Table 27. Typical  $V_{OD}$  Setting for GX Channel, TX Termination = 100  $\Omega$  <sup>(2)</sup>**

| Symbol  | $V_{OD}$ Setting | $V_{OD}$ Value (mV) | $V_{OD}$ Setting | $V_{OD}$ Value (mV) |
|---|------------------|---------------------|------------------|---------------------|
| <b><math>V_{OD}</math> differential peak to peak typical <sup>(3)</sup></b> | 0 <sup>(1)</sup> | 0                   | 32               | 640                 |
|   | 1 <sup>(1)</sup> | 20                  | 33               | 660                 |
|   | 2 <sup>(1)</sup> | 40                  | 34               | 680                 |
|   | 3 <sup>(1)</sup> | 60                  | 35               | 700                 |
|   | 4 <sup>(1)</sup> | 80                  | 36               | 720                 |
|   | 5 <sup>(1)</sup> | 100                 | 37               | 740                 |
|   | 6                | 120                 | 38               | 760                 |
|   | 7                | 140                 | 39               | 780                 |
|   | 8                | 160                 | 40               | 800                 |
|   | 9                | 180                 | 41               | 820                 |
|   | 10               | 200                 | 42               | 840                 |
|   | 11               | 220                 | 43               | 860                 |
|   | 12               | 240                 | 44               | 880                 |
|   | 13               | 260                 | 45               | 900                 |
|   | 14               | 280                 | 46               | 920                 |
|   | 15               | 300                 | 47               | 940                 |
|   | 16               | 320                 | 48               | 960                 |
|   | 17               | 340                 | 49               | 980                 |
|   | 18               | 360                 | 50               | 1000                |
|   | 19               | 380                 | 51               | 1020                |
|   | 20               | 400                 | 52               | 1040                |
|   | 21               | 420                 | 53               | 1060                |
|   | 22               | 440                 | 54               | 1080                |
|   | 23               | 460                 | 55               | 1100                |
|   | 24               | 480                 | 56               | 1120                |
|   | 25               | 500                 | 57               | 1140                |
|   | 26               | 520                 | 58               | 1160                |
|   | 27               | 540                 | 59               | 1180                |
|   | 28               | 560                 | 60               | 1200                |
|   | 29               | 580                 | 61               | 1220                |
|   | 30               | 600                 | 62               | 1240                |
|   | 31               | 620                 | 63               | 1260                |

**Note to Table 27:**

- (1) If TX termination resistance = 100 $\Omega$ , this VOD setting is illegal.
- (2) The tolerance is +/-20% for all VOD settings except for settings 2 and below.
- (3) Refer to Figure 2.

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 1 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions   | Transceiver<br>Speed Grade 2   |           |      | Transceiver<br>Speed Grade 3 |           |      | Unit |
|--|--|--|-----------|------|------------------------------|-----------|------|------|
|  |  | Min  | Typ       | Max  | Min                          | Typ       | Max  |      |
| Reference Clock  |  |  |           |      |                              |           |      |      |
| Supported I/O<br>Standards                                     | Dedicated<br>reference<br>clock pin                    | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS,<br>and HCSL |           |      |                              |           |      |      |
|  | RX reference<br>clock pin                              | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS                                   |           |      |                              |           |      |      |
| Input Reference Clock<br>Frequency (CMU<br>PLL) <sup>(6)</sup> | —  | 40   | —         | 710  | 40                           | —         | 710  | MHz  |
| Input Reference Clock<br>Frequency (ATX PLL) <sup>(6)</sup>    | —  | 100  | —         | 710  | 100                          | —         | 710  | MHz  |
| Rise time  | 20% to 80%   | —  | —         | 400  | —                            | —         | 400  | ps   |
| Fall time  | 80% to 20%   | —  | —         | 400  | —                            | —         | 400  |      |
| Duty cycle   | —  | 45   | —         | 55   | 45                           | —         | 55   | %    |
| Spread-spectrum<br>modulating clock<br>frequency               | PCI Express<br>(PCIe)                                  | 30   | —         | 33   | 30                           | —         | 33   | kHz  |
| Spread-spectrum<br>downspread                                  | PCIe   | —  | 0 to −0.5 | —    | —                            | 0 to −0.5 | —    | %    |
| On-chip termination<br>resistors <sup>(19)</sup>               | —  | —  | 100       | —    | —                            | 100       | —    | Ω    |
| Absolute V <sub>MAX</sub> <sup>(3)</sup>                       | Dedicated<br>reference<br>clock pin                    | —  | —         | 1.6  | —                            | —         | 1.6  | V    |
|  | RX reference<br>clock pin                              | —  | —         | 1.2  | —                            | —         | 1.2  |      |
| Absolute V <sub>MIN</sub>                                      | —  | -0.4   | —         | —    | -0.4                         | —         | —    | V    |
| Peak-to-peak<br>differential input<br>voltage                  | —  | 200  | —         | 1600 | 200                          | —         | 1600 | mV   |
| V <sub>ICM</sub> (AC coupled)                                  | Dedicated<br>reference<br>clock pin                    | 1050/1000 <sup>(2)</sup>   |           |      | 1050/1000 <sup>(2)</sup>     |           |      | mV   |
|  | RX reference<br>clock pin                              | 1.0/0.9/0.85 <sup>(22)</sup>   |           |      | 1.0/0.9/0.85 <sup>(22)</sup> |           |      | V    |
| V <sub>ICM</sub> (DC coupled)                                  | HCSL I/O<br>standard for<br>PCIe<br>reference<br>clock | 250  | —         | 550  | 250                          | —         | 550  | mV   |

Table 29 shows the  $V_{OD}$  settings for the GT channel.

**Table 29. Typical  $V_{OD}$  Setting for GT Channel, TX Termination = 100  $\Omega$**

| Symbol  | $V_{OD}$ Setting | $V_{OD}$ Value (mV) |
|---|------------------|---------------------|
| <b><math>V_{OD}</math> differential peak to peak typical <sup>(1)</sup></b> | 0                | 0                   |
|   | 1                | 200                 |
|   | 2                | 400                 |
|   | 3                | 600                 |
|   | 4                | 800                 |
|   | 5                | 1000                |

**Note:**

(1) Refer to Figure 4.

- XFI
- ASI
- HiGig/HiGig+
- HiGig2/HiGig2+
- Serial Data Converter (SDC)
- GPON
- SDI
- SONET
- Fibre Channel (FC)
- PCIe
- QPI
- SFF-8431

Download the Stratix V Characterization Report Tool to view the characterization report summary for these protocols.

## Core Performance Specifications

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), memory blocks, configuration, and JTAG specifications.

### Clock Tree Specifications

Table 30 lists the clock tree specifications for Stratix V devices.

**Table 30. Clock Tree Performance for Stratix V Devices <sup>(1)</sup>**

| Symbol                    | Performance              |                       |        | Unit |
|---------------------------|--------------------------|-----------------------|--------|------|
|                           | C1, C2, C2L, I2, and I2L | C3, I3, I3L, and I3YY | C4, I4 |      |
| Global and Regional Clock | 717                      | 650                   | 580    | MHz  |
| Periphery Clock           | 550                      | 500                   | 500    | MHz  |

**Note to Table 30:**

(1) The Stratix V ES devices are limited to 600 MHz core clock tree performance.

**Table 33. Memory Block Performance Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Memory     | Mode   | Resources Used |        | Performance |         |     |     |         |               |     | Unit |
|------------|--|----------------|--------|-------------|---------|-----|-----|---------|---------------|-----|------|
|            |  | ALUTs          | Memory | C1          | C2, C2L | C3  | C4  | I2, I2L | I3, I3L, I3YY | I4  |      |
| M20K Block | Single-port, all supported widths  | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | Simple dual-port, all supported widths   | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | Simple dual-port with the read-during-write option set to <b>Old Data</b> , all supported widths | 0              | 1      | 525         | 525     | 455 | 400 | 525     | 455           | 400 | MHz  |
|            | Simple dual-port with ECC enabled, 512 × 32  | 0              | 1      | 450         | 450     | 400 | 350 | 450     | 400           | 350 | MHz  |
|            | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32                      | 0              | 1      | 600         | 600     | 500 | 450 | 600     | 500           | 450 | MHz  |
|            | True dual port, all supported widths   | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | ROM, all supported widths  | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |

**Notes to Table 33:**

- (1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50%** output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.
- (2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in F<sub>MAX</sub>.
- (3) The F<sub>MAX</sub> specification is only achievable with Fitter options, **MLAB Implementation In 16-Bit Deep Mode** enabled.

**Temperature Sensing Diode Specifications**

Table 34 lists the internal TSD specification.

**Table 34. Internal Temperature Sensing Diode Specification**

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate  | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|-------------------|----------|--------------------------|----------------|-----------------|------------|--|
| –40°C to 100°C    | ±8°C     | No                       | 1 MHz, 500 KHz | < 100 ms        | 8 bits     | 8 bits                                   |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

**Table 35. External Temperature Sensing Diode Specifications for Stratix V Devices**

| Description                              | Min   | Typ   | Max   | Unit |
|--|-------|-------|-------|------|
| I <sub>bias</sub> , diode source current | 8     | —     | 200   | μA   |
| V <sub>bias</sub> , voltage across diode | 0.3   | —     | 0.9   | V    |
| Series resistance                        | —     | —     | < 1   | Ω    |
| Diode ideality factor                    | 1.006 | 1.008 | 1.010 | —    |



## Periphery Performance

This section describes periphery performance, including high-speed I/O and external memory interface.

I/O performance supports several system interfaces, such as the **LVDS** high-speed I/O interface, external memory interface, and the **PCI/PCI-X** bus interface.

General-purpose I/O standards such as 3.3-, 2.5-, 1.8-, and 1.5-**LVTTL/LVCMOS** are capable of a typical 167 MHz and 1.2-**LVCMOS** at 100 MHz interfacing frequency with a 10 pF load.



The actual achievable frequency depends on design- and system-specific factors. Ensure proper timing closure in your design and perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

### High-Speed I/O Specification

Table 36 lists high-speed I/O timing for Stratix V devices.

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 1 of 4)**

| Symbol   | Conditions   | C1  |     |     | C2, C2L, I2, I2L |     |     | C3, I3, I3L, I3YY |     |                    | C4,I4 |     |                    | Unit |
|--|--|-----|-----|-----|------------------|-----|-----|-------------------|-----|--------------------|-------|-----|--------------------|------|
|  |  | Min | Typ | Max | Min              | Typ | Max | Min               | Typ | Max                | Min   | Typ | Max                |      |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>True Differential I/O Standards           | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625                | 5     | —   | 525                | MHz  |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>Single Ended I/O Standards <sup>(3)</sup> | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625                | 5     | —   | 525                | MHz  |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>Single Ended I/O Standards                | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 520 | 5                | —   | 520 | 5                 | —   | 420                | 5     | —   | 420                | MHz  |
| $f_{\text{HCLK\_OUT}}$<br>(output clock frequency)   | —  | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625 <sup>(5)</sup> | 5     | —   | 525 <sup>(5)</sup> | MHz  |

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 2 of 4)**

| Symbol   | Conditions  | C1  |     |      | C2, C2L, I2, I2L |     |      | C3, I3, I3L, I3YY |     |      | C4,I4 |     |      | Unit |
|--|---|-----|-----|------|------------------|-----|------|-------------------|-----|------|-------|-----|------|------|
|  |   | Min | Typ | Max  | Min              | Typ | Max  | Min               | Typ | Max  | Min   | Typ | Max  |      |
| Transmitter  |   |     |     |      |                  |     |      |                   |     |      |       |     |      |      |
| True Differential I/O Standards - f <sub>HSDR</sub> (data rate)  | SERDES factor J = 3 to 10 <sup>(9), (11), (12), (13), (14), (15), (16)</sup>  | (6) | —   | 1600 | (6)              | —   | 1434 | (6)               | —   | 1250 | (6)   | —   | 1050 | Mbps |
|  | SERDES factor J ≥ 4<br><br>LVDS TX with DPA <sup>(12), (14), (15), (16)</sup> | (6) | —   | 1600 | (6)              | —   | 1600 | (6)               | —   | 1600 | (6)   | —   | 1250 | Mbps |
|  | SERDES factor J = 2,<br>uses DDR Registers                                    | (6) | —   | (7)  | (6)              | —   | (7)  | (6)               | —   | (7)  | (6)   | —   | (7)  | Mbps |
|  | SERDES factor J = 1,<br>uses SDR Register                                     | (6) | —   | (7)  | (6)              | —   | (7)  | (6)               | —   | (7)  | (6)   | —   | (7)  | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f <sub>HSDR</sub> (data rate) <sup>(10)</sup> | SERDES factor J = 4 to 10 <sup>(17)</sup>                                     | (6) | —   | 1100 | (6)              | —   | 1100 | (6)               | —   | 840  | (6)   | —   | 840  | Mbps |
| t <sub>x Jitter</sub> - True Differential I/O Standards  | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps                               | —   | —   | 160  | —                | —   | 160  | —                 | —   | 160  | —     | —   | 160  | ps   |
|  | Total Jitter for Data Rate < 600 Mbps   | —   | —   | 0.1  | —                | —   | 0.1  | —                 | —   | 0.1  | —     | —   | 0.1  | UI   |
| t <sub>x Jitter</sub> - Emulated Differential I/O Standards with Three External Output Resistor Network                          | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps                               | —   | —   | 300  | —                | —   | 300  | —                 | —   | 300  | —     | —   | 325  | ps   |
|  | Total Jitter for Data Rate < 600 Mbps   | —   | —   | 0.2  | —                | —   | 0.2  | —                 | —   | 0.2  | —     | —   | 0.25 | UI   |

**Table 47. Uncompressed .rbf Sizes for Stratix V Devices**

| Family                     | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) <sup>(4), (5)</sup> |
|----------------------------|--------|---------|--------------------------------|--|
| Stratix V E <sup>(1)</sup> | 5SEE9  | —       | 342,742,976                    | 700,888                                    |
|                            | 5SEEB  | —       | 342,742,976                    | 700,888                                    |

**Notes to Table 47:**

- (1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.
- (2) 36-transceiver devices.
- (3) 24-transceiver devices.
- (4) File size for the periphery image.
- (5) The IOCSR .rbf size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (.hex) or tabular text file (.tff) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.



For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices*. For creating configuration files, refer to the *Quartus II Help*.

Table 48 lists the minimum configuration time estimates for Stratix V devices.

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial <sup>(1)</sup> |            |                     | Fast Passive Parallel <sup>(2)</sup> |            |                     |
|---------|-------------|------------------------------|------------|---------------------|--------------------------------------|------------|---------------------|
|         |             | Width                        | DCLK (MHz) | Min Config Time (s) | Width                                | DCLK (MHz) | Min Config Time (s) |
| GX      | A3          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         |             | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | A4          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         | A5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | AB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | B5          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B6          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | BB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
| GT      | C5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | C7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial <sup>(1)</sup> |            |                     | Fast Passive Parallel <sup>(2)</sup> |            |                     |
|---------|-------------|------------------------------|------------|---------------------|--------------------------------------|------------|---------------------|
|         |             | Width                        | DCLK (MHz) | Min Config Time (s) | Width                                | DCLK (MHz) | Min Config Time (s) |
| GS      | D3          | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | D4          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         |             | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | D5          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         | D6          | 4                            | 100        | 0.741               | 32                                   | 100        | 0.093               |
|         | D8          | 4                            | 100        | 0.741               | 32                                   | 100        | 0.093               |
| E       | E9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | EB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |

**Notes to Table 48:**

(1) DCLK frequency of 100 MHz using external CLKUSR.

(2) Max FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

## Fast Passive Parallel Configuration Timing

This section describes the fast passive parallel (FPP) configuration timing parameters for Stratix V devices.

### DCLK-to-DATA[] Ratio for FPP Configuration

FPP configuration requires a different DCLK-to-DATA [] ratio when you enable the design security, decompression, or both features. Table 49 lists the DCLK-to-DATA [] ratio for each combination.

**Table 49. DCLK-to-DATA[] Ratio <sup>(1)</sup> (Part 1 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|----------------------|---------------|-----------------|----------------------|
| FPP ×8               | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 1                    |
|                      | Enabled       | Disabled        | 2                    |
|                      | Enabled       | Enabled         | 2                    |
| FPP ×16              | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 2                    |
|                      | Enabled       | Disabled        | 4                    |
|                      | Enabled       | Enabled         | 4                    |

**Table 61. Document Revision History (Part 3 of 3)**

| Date          | Version | Changes  |
|---------------|---------|--|
| May 2013      | 2.7     | <ul style="list-style-type: none"> <li>■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60</li> <li>■ Added Table 24, Table 48</li> <li>■ Updated Figure 9, Figure 10, Figure 11, Figure 12</li> </ul>   |
| February 2013 | 2.6     | <ul style="list-style-type: none"> <li>■ Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46</li> <li>■ Updated “Maximum Allowed Overshoot and Undershoot Voltage”</li> </ul>   |
| December 2012 | 2.5     | <ul style="list-style-type: none"> <li>■ Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35</li> <li>■ Added Table 33</li> <li>■ Added “Fast Passive Parallel Configuration Timing”</li> <li>■ Added “Active Serial Configuration Timing”</li> <li>■ Added “Passive Serial Configuration Timing”</li> <li>■ Added “Remote System Upgrades”</li> <li>■ Added “User Watchdog Internal Circuitry Timing Specification”</li> <li>■ Added “Initialization”</li> <li>■ Added “Raw Binary File Size”</li> </ul> |
| June 2012     | 2.4     | <ul style="list-style-type: none"> <li>■ Added Figure 1, Figure 2, and Figure 3.</li> <li>■ Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27, Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59.</li> <li>■ Various edits throughout to fix bugs.</li> <li>■ Changed title of document to <i>Stratix V Device Datasheet</i>.</li> <li>■ Removed document from the Stratix V handbook and made it a separate document.</li> </ul>                            |
| February 2012 | 2.3     | <ul style="list-style-type: none"> <li>■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31.</li> </ul>  |
| December 2011 | 2.2     | <ul style="list-style-type: none"> <li>■ Added Table 2–31.</li> <li>■ Updated Table 2–28 and Table 2–34.</li> </ul>  |
| November 2011 | 2.1     | <ul style="list-style-type: none"> <li>■ Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices.</li> <li>■ Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25.</li> <li>■ Various edits throughout to fix SPRs.</li> </ul>  |
| May 2011      | 2.0     | <ul style="list-style-type: none"> <li>■ Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24.</li> <li>■ Updated the “DQ Logic Block and Memory Output Clock Jitter Specifications” title.</li> <li>■ Chapter moved to Volume 1.</li> <li>■ Minor text edits.</li> </ul>   |
| December 2010 | 1.1     | <ul style="list-style-type: none"> <li>■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23.</li> <li>■ Converted chapter to the new template.</li> <li>■ Minor text edits.</li> </ul>   |
| July 2010     | 1.0     | Initial release.   |